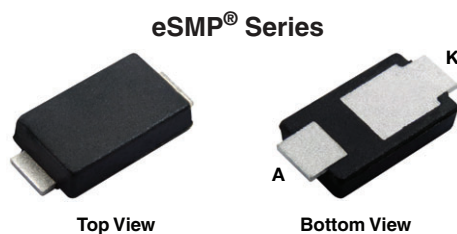


# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



**SMPS (DO-221BC)**

Anode  Cathode

## FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

**Case:** SMPS (DO-221BC)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

## LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS                  |                 |
|------------------------------------------|-----------------|
| $I_{F(AV)}$                              | 8.0 A           |
| $V_{RRM}$                                | 50 V            |
| $I_{FSM}$                                | 120 A           |
| $V_F$ at $I_F = 8.0$ A ( $T_A = 125$ °C) | 0.40 V          |
| $T_J$ max.                               | 150 °C          |
| Package                                  | SMPS (DO-221BC) |
| Circuit configuration                    | Single          |

| MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)                           |                |             |      |
|-----------------------------------------------------------------------------------|----------------|-------------|------|
| PARAMETER                                                                         | SYMBOL         | V8PAL50     | UNIT |
| Device marking code                                                               |                | 8L5         |      |
| Maximum repetitive peak reverse voltage                                           | $V_{RRM}$      | 50          | V    |
| Maximum DC forward current                                                        | $I_F^{(1)}$    | 8.0         | A    |
|                                                                                   | $I_F^{(2)}$    | 4.0         |      |
| Maximum DC reverse voltage                                                        | $V_{DC}$       | 35          | V    |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $I_{FSM}$      | 120         | A    |
| Operating junction and storage temperature range                                  | $T_J, T_{STG}$ | -40 to +150 | °C   |

### Notes

(1) Units mounted on 3 cm x 3 cm Aluminum, 2 oz. PCB

(2) Free air, mounted on recommended copper pad area

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS      | SYMBOL                              | TYP.        | MAX. | UNIT          |
|-------------------------------|----------------------|-------------------------------------|-------------|------|---------------|
| Instantaneous forward voltage | $I_F = 4.0\text{ A}$ | $T_A = 25\text{ }^{\circ}\text{C}$  | $V_F^{(1)}$ | 0.43 | V             |
|                               | $I_F = 8.0\text{ A}$ |                                     |             | 0.49 |               |
|                               | $I_F = 4.0\text{ A}$ | $T_A = 125\text{ }^{\circ}\text{C}$ | $V_F^{(1)}$ | 0.32 |               |
|                               | $I_F = 8.0\text{ A}$ |                                     |             | 0.40 |               |
| Reverse current               | $V_R = 35\text{ V}$  | $T_A = 25\text{ }^{\circ}\text{C}$  | $I_R^{(2)}$ | 10   | $\mu\text{A}$ |
|                               |                      | $T_A = 125\text{ }^{\circ}\text{C}$ |             | 8.4  | mA            |
|                               | $V_R = 50\text{ V}$  | $T_A = 25\text{ }^{\circ}\text{C}$  |             | -    | $\mu\text{A}$ |
|                               |                      | $T_A = 125\text{ }^{\circ}\text{C}$ |             | 15   | mA            |
| Typical junction capacitance  | 4.0 V, 1 MHz         | $C_J$                               | 1400        | -    | pF            |

**Notes**

(1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq 5\text{ ms}$ 
**THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

| PARAMETER                  | SYMBOL                | V8PAL50 | UNIT                 |
|----------------------------|-----------------------|---------|----------------------|
| Typical thermal resistance | $R_{\theta JA}^{(1)}$ | 100     | $^{\circ}\text{C/W}$ |
|                            | $R_{\theta JM}^{(2)}$ | 5       |                      |

**Notes**

(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient

(2) Units mounted on 3 cm x 3 cm Aluminum, 2 oz. pad area; thermal resistance  $R_{\theta JM}$  - junction to mount

**ORDERING INFORMATION** (Example)

| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|---------------|-----------------|------------------------|---------------|------------------------------------|
| V8PAL50-M3/I  | 0.032           | I                      | 14 000        | 13" diameter plastic tape and reel |

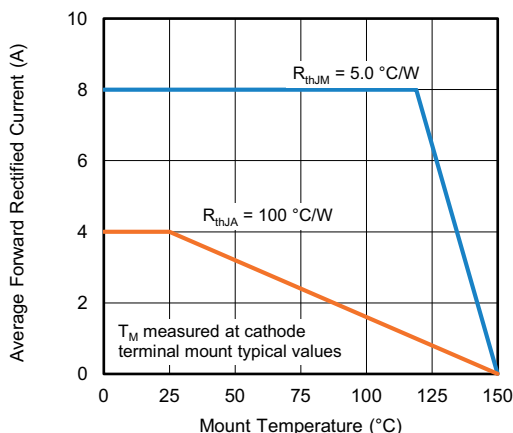
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)


Fig. 1 - Maximum Forward Current Derating Curve

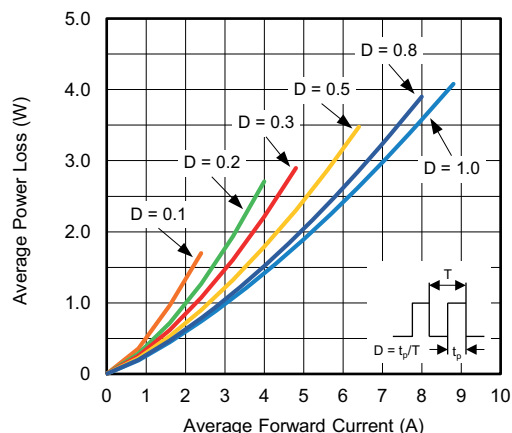


Fig. 2 - Forward Power Loss Characteristics

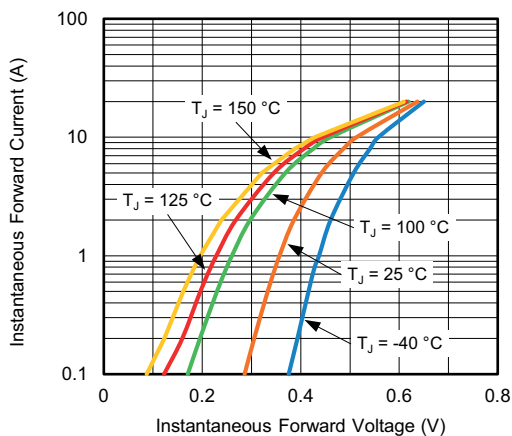


Fig. 3 - Typical Instantaneous Forward Characteristics

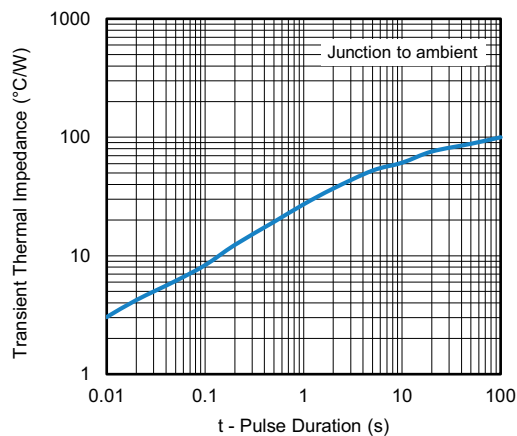


Fig. 6 - Typical Transient Thermal Impedance

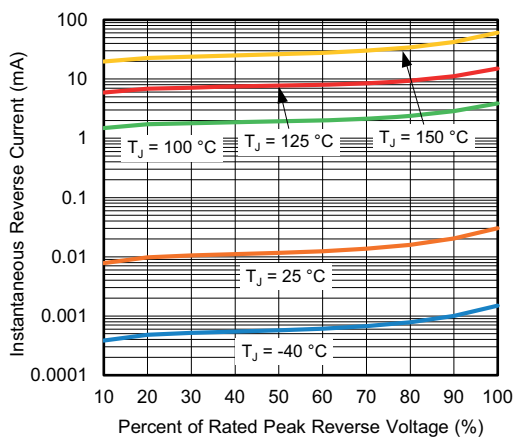


Fig. 4 - Typical Reverse Leakage Characteristics

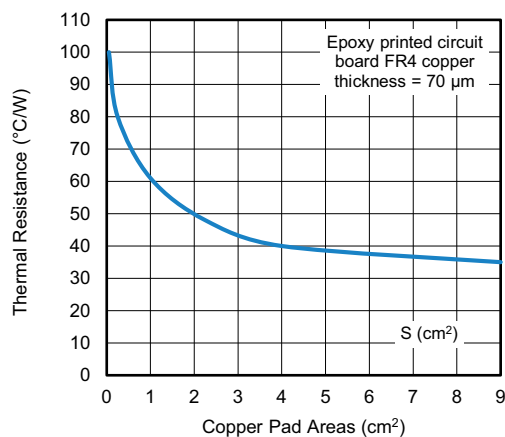


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

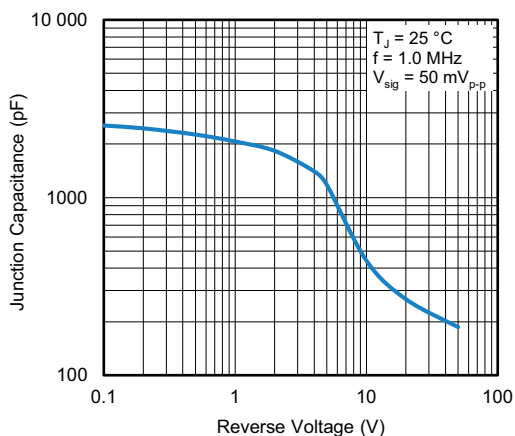
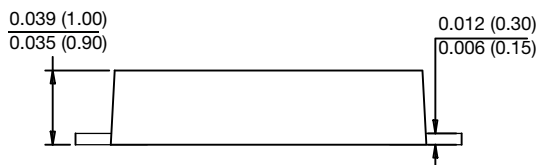
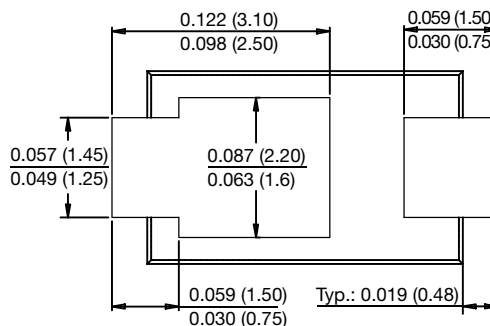
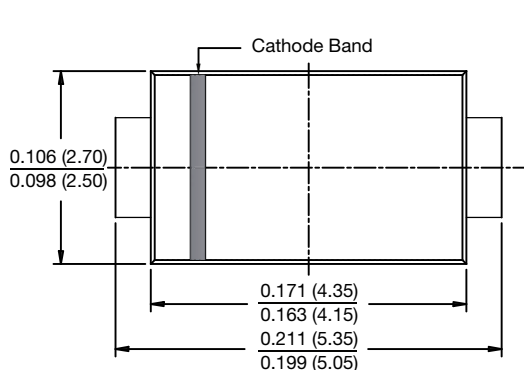


Fig. 5 - Typical Junction Capacitance

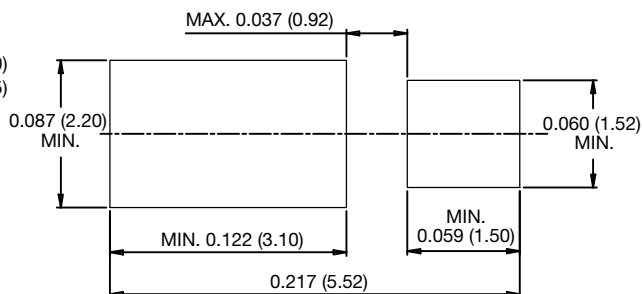


**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

**SMPA (DO-221BC)**



**Mounting Pad Layout**





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